

Features

- $BV_{CEO} > 160V$
- $BV_{EBO} > 6V$
- $I_C = 600mA$ Continuous Collector Current
- Low Saturation Voltage (150mV max @10mA)
- h_{FE} specified up to 50mA for a high gain hold up
- Complementary PNP Type: DZT5401
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Applications

- High Voltage Amplification Applications
- High Voltage Switching

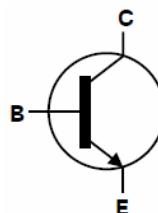
Mechanical Data

- Case: SOT223
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 
- Weight: 0.112 grams (approximate)

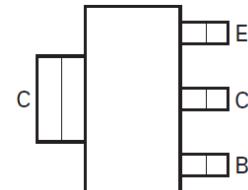
SOT223



Top View



Device Schematic



Pin-Out Top View

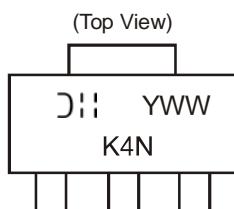
Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DZT5551-13	K4N	13	12	2,500

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <http://www.diodes.com>

Marking Information



(Top View)

K4N = Product type marking code
 DII = Manufacturer's code marking
 YWW = Date code marking
 Y = Last digit of year ex: 7 = 2007
 WW = Week code 01 - 52

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

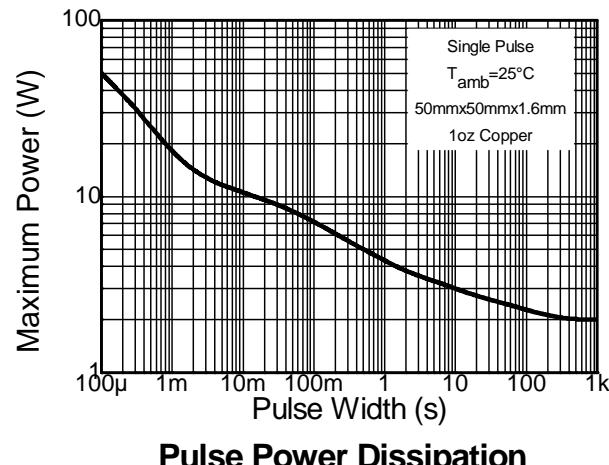
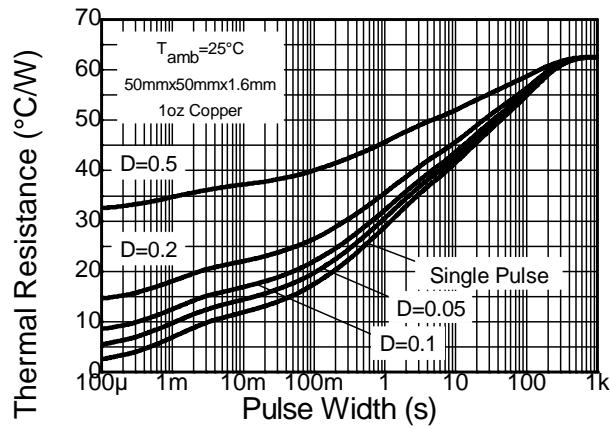
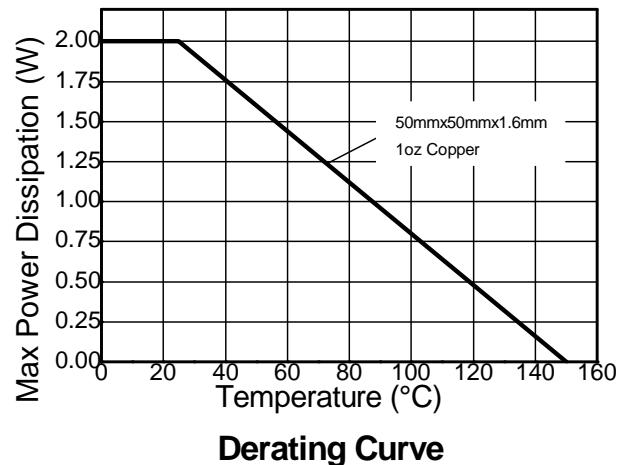
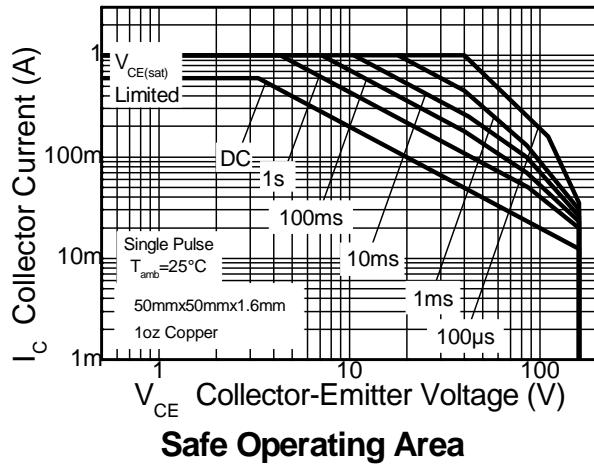
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	180	V
Collector-Emitter Voltage	V_{CEO}	160	V
Emitter-Base Voltage	V_{EBO}	6	V
Continuous Collector Current	I_C	600	mA
Peak Collector Current	I_{CM}	1	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	2	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	62.5	°C/W
Thermal Resistance, Junction to Leads (Note 6)	$R_{\theta JL}$	34.05	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Notes: 5. Device mounted on 50mm X 50mm X 1.6mm FR-4 PCB with high coverage of single sided 1 oz. copper, in still air condition
6. Thermal resistance from junction to solder-point (at the end of the collector lead).

Thermal Characteristics and Derating Information

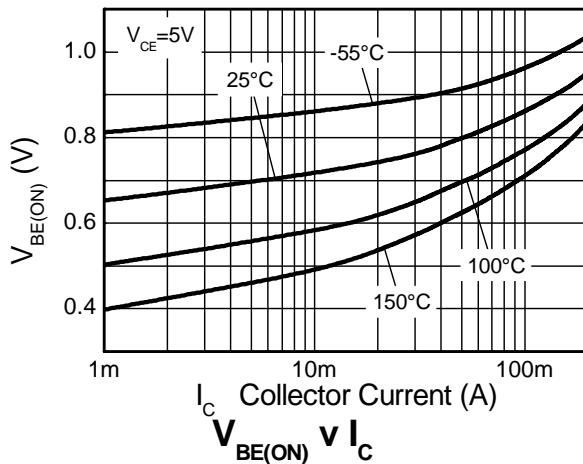
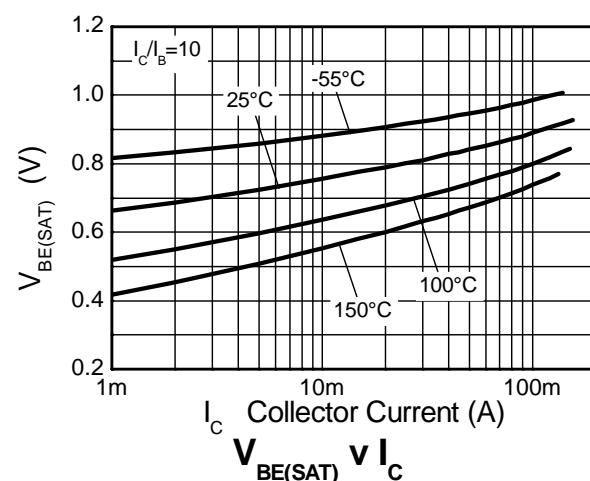
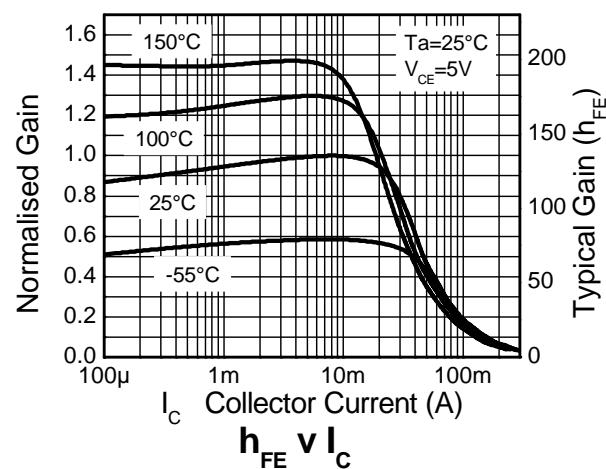
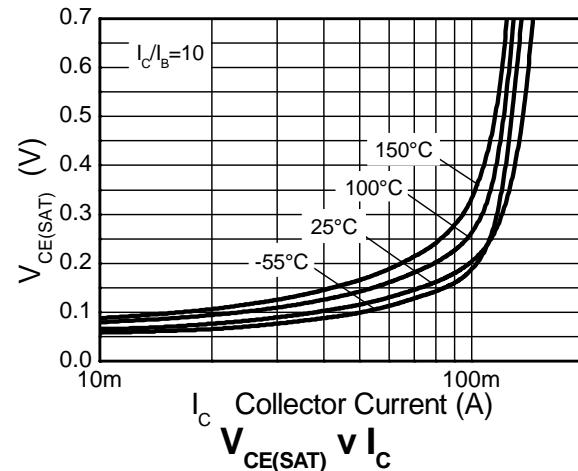
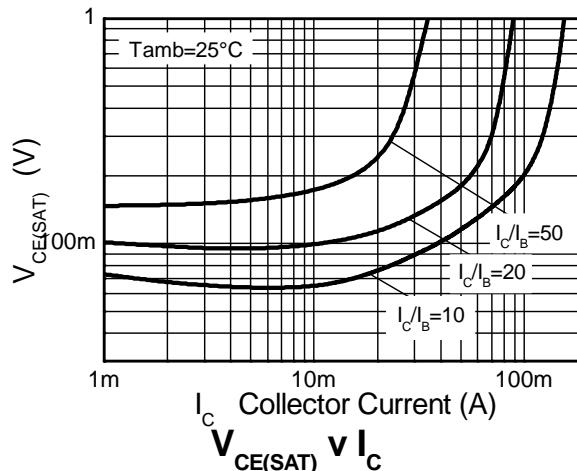


Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV_{CBO}	180	270	—	V	$I_C = 100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 7)	BV_{CEO}	160	200	—	V	$I_C = 1\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV_{EBO}	6.0	7.85	—	V	$I_E = 100\mu\text{A}, I_C = 0$
Collector Cutoff Current	I_{CBO}	—	<1	50	nA	$V_{\text{CB}} = 120\text{V}, I_E = 0$
		—	—	50	μA	$V_{\text{CB}} = 120\text{V}, I_E = 0, T_A = +100^\circ\text{C}$
Emitter Cutoff Current	I_{EBO}	—	<1	50	nA	$V_{\text{EB}} = 4\text{V}, I_C = 0$
ON CHARACTERISTICS (Note 7)						
Collector-Emitter Saturation Voltage	$V_{\text{CE}(\text{sat})}$	—	65 115	150 200	mV mV	$I_C = 10\text{mA}, I_B = 1\text{mA}$ $I_C = 50\text{mA}, I_B = 5\text{mA}$
Base-Emitter Saturation Voltage	$V_{\text{BE}(\text{sat})}$	—	760 840	1000 1200	mV mV	$I_C = 10\text{mA}, I_B = 1\text{mA}$ $I_C = 50\text{mA}, I_B = 5\text{mA}$
DC Current Gain	h_{FE}	80 80 30	130 145 65	— 250 —	—	$I_C = 1\text{mA}, V_{\text{CE}} = 5\text{V}$ $I_C = 10\text{mA}, V_{\text{CE}} = 5\text{V}$ $I_C = 50\text{mA}, V_{\text{CE}} = 5\text{V}$
SMALL SIGNAL CHARACTERISTICS						
Transition Frequency	f_T	100	130	300	MHz	$V_{\text{CE}} = 10\text{V}, I_C = 10\text{mA}, f = 100\text{MHz}$
Small Signal Current Gain	h_{fe}	50	—	260	—	$V_{\text{CE}} = 10\text{V}, I_C = 10\text{mA}, f = 1\text{kHz}$
Output Capacitance	C_{obo}	—	—	6	pF	$V_{\text{CB}} = 10\text{V}, f = 1\text{MHz}$
Noise Figure	NF	—	—	8	dB	$V_{\text{CE}} = 5.0\text{V}, I_C = 200\mu\text{A}, R_S = 1.0\text{k}\Omega, f = 1.0\text{kHz}$
Delay Time	$t_{(d)}$	—	95	—	ns	$V_{\text{CC}} = 10\text{V}, I_C = 10\text{mA}, I_{B1} = -I_{B2} = 1\text{mA}$
Rise Time	$t_{(r)}$	—	64	—	ns	
Storage Time	$t_{(s)}$	—	1256	—	ns	
Delay Time	$t_{(f)}$	—	140	—	ns	

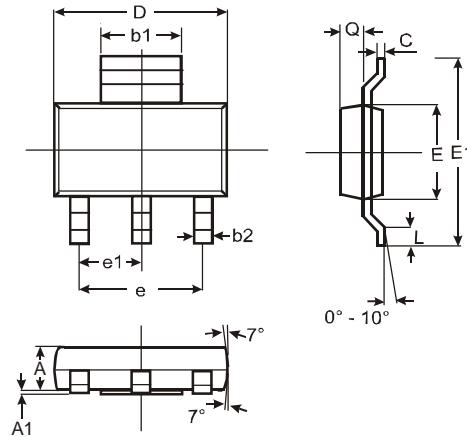
Notes: 7. Pulse Test: Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2.0\%$.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

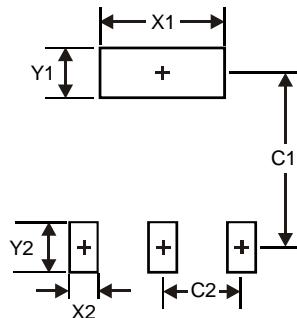


SOT223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b1	2.90	3.10	3.00
b2	0.60	0.80	0.70
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	—	—	4.60
e1	—	—	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89

All Dimensions in mm

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3

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